



(1,27 mm) .050"

FW-10-04-L-D-440-150

FW-40-02-F-D-425-075

FW-20-02-F-D-200-140

FW-TH SERIES

# THROUGH-HOLE MICRO BOARD STACKER

## SPECIFICATIONS

For complete specifications see [www.samtec.com?FW-TH](http://www.samtec.com?FW-TH)

**Insulator Material:**  
Black Liquid Crystal Polymer

**Terminal Material:**  
Phosphor Bronze

**Plating:**

Sn or Au over  
50µ" (1,27 µm) Ni

**Operating Temp Range:**  
-55°C to +125°C

**RoHS Compliant:**  
Yes

**Processing:**  
Lead-Free Solderable:  
Yes

Mates with:  
CLP, FFSD, FLE

Low profile or  
skyscraper styles

Variable  
board spacing

(1,27 mm)  
.050" pitch

## RECOGNITIONS

For complete scope  
of recognitions see  
[www.samtec.com/quality](http://www.samtec.com/quality)

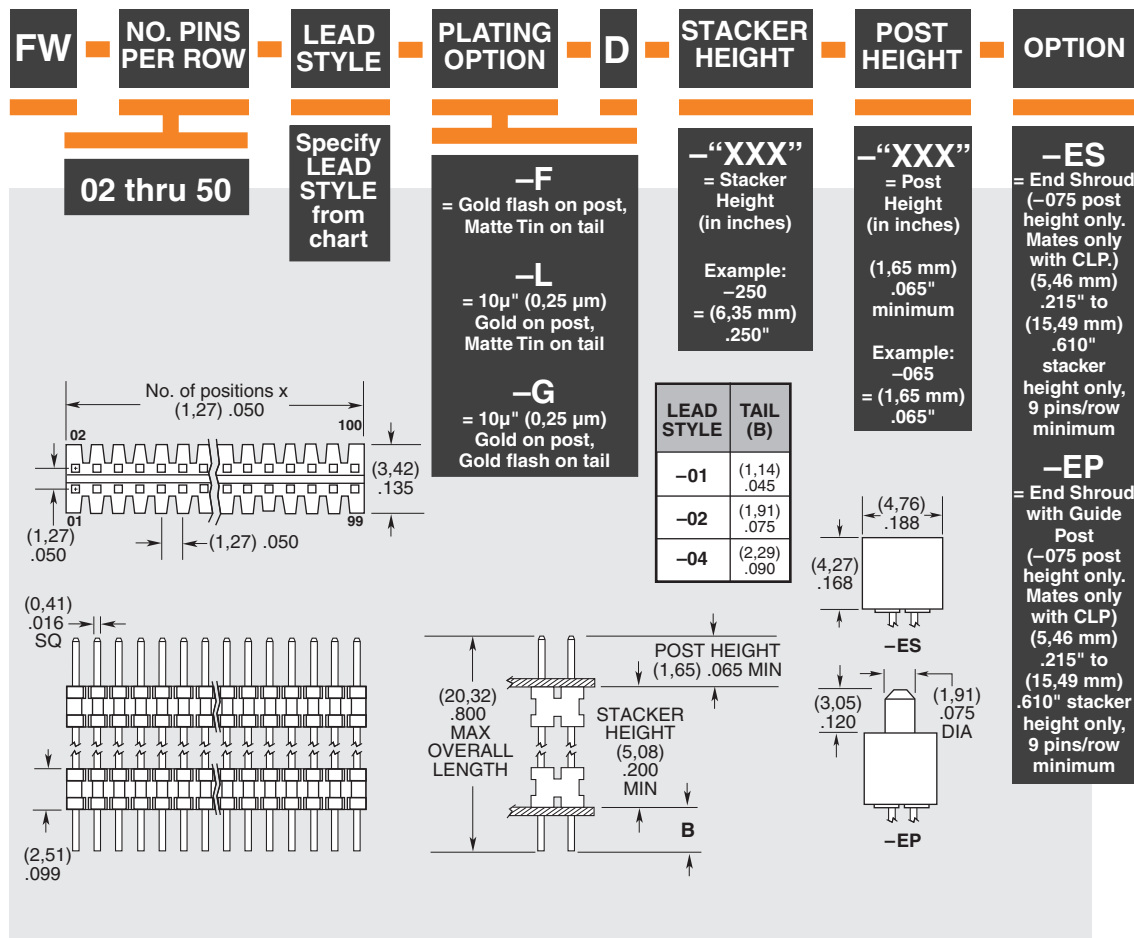


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## ALSO AVAILABLE (MOQ Required)

- Smaller stack heights  
Contact Samtec.



**Note:** For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact [ipg@samtec.com](mailto:ipg@samtec.com) for more information.

**Note:** This Series is non-standard, non-returnable.